	RM PTO-1595 RECC 01	-08	-2001 U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office		
ОМ	OMB No. 0651-0011 (exp. 4/94)				
	$\frac{\text{Tab Settings} \Rightarrow \Rightarrow \nabla \qquad \nabla \qquad \nabla}{\text{To the Assistant Commissioner of Patents: reas}}$	0157	5309 <sup>V</sup>		
	To the Assistant Commissioner of Patents: rieas	e recoru	the anached original documents or copy thereof.		
1.	Name of conveying parties:	2.	Name and address of receiving party:		
	Katsuyuki Kanetaka A 7 2000 Toshio Fukui	3	Name: Sony Computer Entertainment, Inc.		
	TOSINO PUKUI	چ ا	Internal Address: 1-1, Akasaka 7-chome		
Add	ditional names of conveying parties attached?   Yes   ADEMARY		Minato-ku, Tokyo 107-0052 JAPAN		
3.	Nature of Conveyance:				
			Street Address:		
	☐ Security Agreement ☐ Change of Name				
	□ Other		City: State: ZIP:		
Exe	ecution Date:				
			Additional names & addresses attached? □ Yes ☒ No		
4.	Application number: 09/660,524		Additional harmes de addresses attached. D 105 ES 110		
٦.		in the c	i data afalia ali-atiia.		
	If this document is being filed together with a new application	ion, the e	••		
	A. Patent Application No.(s)		B. Patent No.(s)		
Additional numbers attached? ☐ Yes ☒ No					
5.	Name and address of party to whom correspondence concerning document should be mailed:	6.	Total Number of applications and patents involved:		
	Name: Michael E. Dergosits, Esq.	7.	Total fee (37 CFR 3.41)\$ 40.00		
	Internal Address: Four Embarcadero Center, Suite 1150				
	San Francisco, CA 94111		Authorized to be charged to deposit account		
		8.	Deposit account number:		
	Street Address:		04-0822		
	City: State: Zip:		(Attach duplicate copy of this page if paying by deposit account)		
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1 FC:581 40.00 CH					
	Paul K. Tomita, Reg. 43.196 Name of Person Signing	Signature	December 22, 2000 Date		

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents, Box Assignments

Washington, D.C. 20231

SCEI Ref.: SC00065US00 TMK Ref.: SC155101

DOCKET NO. 444.08.01

## **ASSIGNMENT**

WHEREAS. I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

## METHOD OF CREATING A DYNAMIC IMAGE, STORAGE MEDIUM AND PROGRAM EXECUTING APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 09/660,524, Filing Date: September 13, 2000.

This assignment executed on the dates indicated below.

Katsuyuki KANETAKA	2000.12.14	
Name of First or Sole Inventor	Execution Date of U.S. Patent Application	
Tokyo, Japan		
Residence of First or Sole Inventor		
Katsuyuki Kavetaka	2000.12.14	
Signature of First or Sole Inventor	Date of this Assignment	

Toshio FUKUI	2000/12/8
Name of Second Inventor	Execution Date of U.S. Patent Application
Tokyo, Japan	<u> </u>
Residence of Second Inventor	
Toshio Fukui	2000/12/8
Signature of Second Inventor	Date of this Assignment
Name of Third Inventor	Execution Date of U.S. Patent Application
Residence of Third Inventor	
Signature of Third Inventor	Date of this Assignment
Name of Fourth Inventor	Execution Date of U.S. Patent Application
Residence of Fourth Inventor	
Signature of Fourth Inventor	Date of this Assignment
Name of Fifth Inventor	Execution Date of U.S. Patent Application
Residence of Fifth Inventor	
Signature of Fifth Inventor	Date of this Assignment

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